Surface Mount \mathbf{I} **RF Transformer** 50Ω 0.4 to 500 MHz

Features

- usable over 0.4-500 MHz
- excellent amplitude unbalance, 0.1 dB typ. and phase unbalance, 2 deg typ. in 1 dB bandwidth
- good return loss
- plastic base with leads
- aqueous washable

Applications

- VHF/UHF receivers/transmitters
- push-pull amplifiers





Generic photo used for illustration purposes only

CASE STYLE: AT1521

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Тур.	Max.	Unit	
Impedance Ratio			1		Ohm	
Frequency Range		0.4		500	MHz	
	0.4-500		3			
Insertion Loss*	0.5-300		2		dB	
	1-100		1			
Amplitude Unhelence	1-100		0.1		dD	
Amplitude Unbalance	0.5-300		0.6		dB	
Phase Unbalance	1-100		2		Degree	
	0.5-300		5		Degree	

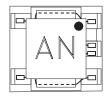
* Insertion Loss is referenced to mid-band loss, 0.35 dB typ.

Maximum Ratings

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

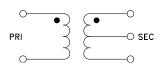
Product Marking



Pin Connections

Function	Pin Number
PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
SECONDARY CT	2

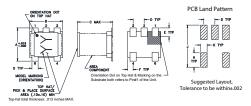
Config. A



Demo Board MCL P/N: TB-145

TC1-1TX+

Outline Drawing

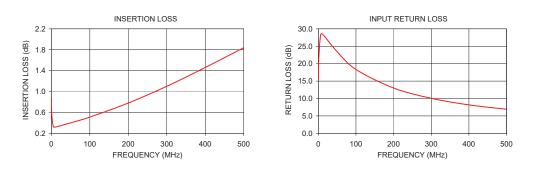


Outline Dimensions (inch)

Α	В	С	D	E	F	G	н	J
.150	.150	.160	.050	.040	.025	.028	.065	.190
3.81	3.81	4.06	1.27	1.02	0.64	0.71	1.65	4.83

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
0.30	0.88	15.46	0.06	0.03
1.00	0.57	21.01	0.04	0.05
5.00	0.33	27.35	0.02	0.01
10.00	0.32	28.55	0.02	0.15
50.00	0.40	23.46	0.02	0.63
100.00	0.51	18.34	0.06	1.24
200.00	0.78	13.01	0.21	2.57
300.00	1.10	10.06	0.47	3.99
400.00	1.46	8.16	0.82	5.66
500.00	1.84	6.90	1.26	7.50



Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



RF Transformer

Typical Performance Data

FREQUENCY MHz	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
0.3	0.88	15.46	0.06	0.03
1.0	0.57	21.01	0.04	0.05
5.0	0.33	27.35	0.02	0.01
10.0	0.32	28.55	0.02	0.15
50.0	0.40	23.46	0.02	0.63
100.0	0.51	18.34	0.06	1.24
200.0	0.78	13.01	0.21	2.57
300.0	1.10	10.06	0.47	3.99
400.0	1.46	8.16	0.82	5.66
500.0	1.84	6.90	1.26	7.50





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 • Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

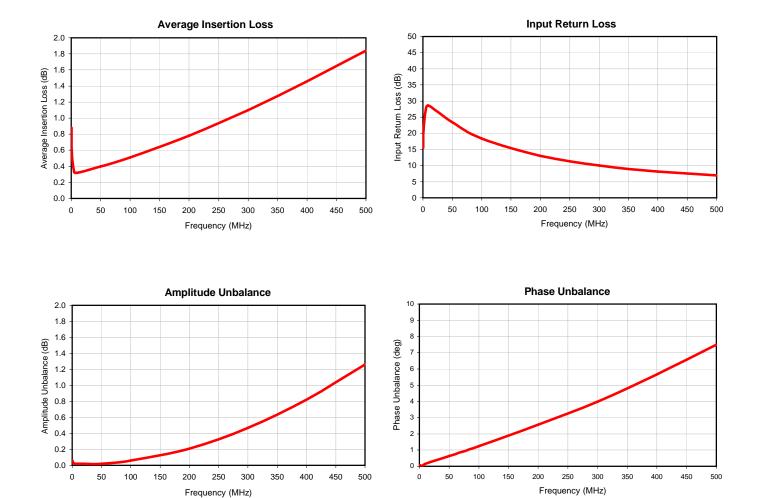
IF/RF MICROWAVE COMPONENTS

TC1-1TX+ 9/2/2011 Page 1 of 1

REV. X1

RF Transformer

Typical Performance Data





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Page 1 of 1

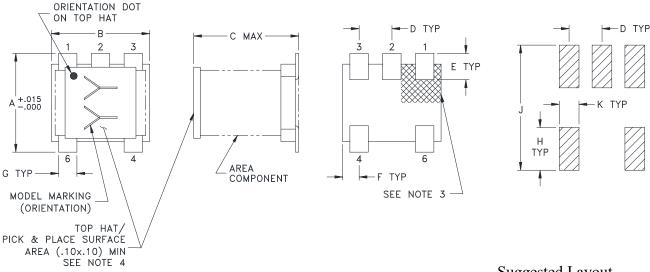
REV. X1

Case Style

Outline Dimensions

PCB Land Pattern

AT1521



Suggested Layout, Tolerance to be within ±.002

CASE #	А	В	С	D	Е	F	G	Н	J	K	WT. GRAMS
AT1521	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (.64)	.028 (.71)	.065 (1.65)	.190 (4.83)	.030 (.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. + .01; 3 Pl. + .005

Notes:

- 1. Case material: Plastic.
- 2. Termination finish:
 - For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
- 3. Orientation Dot on Top Hat & Marking on the Substrate both refers to Pin #1 of the Unit.
- 4. Top-Hat total thickness: .013 inches MAX.



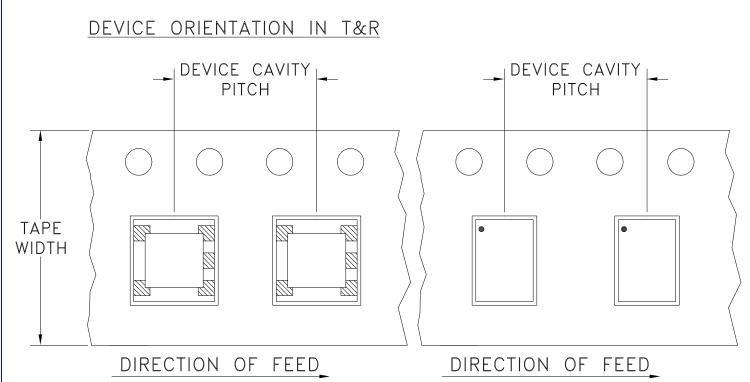


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Tape & Reel Packaging TR-F17



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices	s per Reel
			Small	20
			quantity	50
		7	standards	100
12	8		(see note)	200
				500
		13	C	1000
			Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

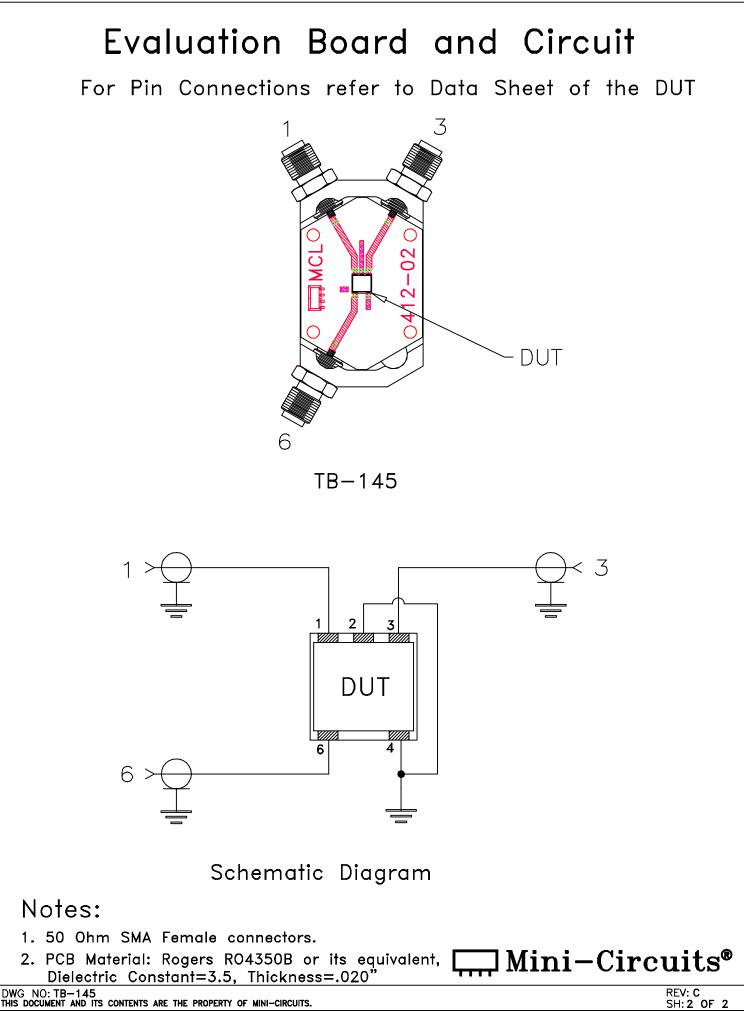




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Mini-Circuits

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02T1 Rev: B 02/25/11 M130240 File: ENV02T1.pdf

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